



SKJERVEN
MORRILL
MACPHERSON LLP

Docket No.: M-9954 US

May 4, 2001

Box Patent Application
Commissioner For Patents
Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventors: Paul Hoffman and Doug Mathews
Title: Shielded Semiconductor Package With Single-Sided Substrate And Method For Making The Same

☒ Return Receipt Postcard
☒ This Transmittal Letter (in duplicate)
7 pages Specification (not including claims)
5 pages Claims
1 page Abstract
4 Sheets of Drawings
2 pages Declaration For Patent Application and Power of Attorney
1 page NonPublication Request
1 page Recordation Form Cover Sheet (in duplicate)
2 pages Assignment
1 page PTO Form 1449 citing seven references
☒ Copies of 7 Cited References submitted

CLAIMS AS FILED

For	Number Filed		Number Extra		Rate		Basic Fee
Total Claims	21	-20 =	1	x	\$ 18.00	=	\$ 18.00
Independent Claims	3	-3 =	0	x	\$80	=	\$ 0.00
<input type="checkbox"/>	Fee of _____ for the first filing of one or more multiple dependent claims per application						\$
<input type="checkbox"/>	Fee for Request for Extension of Time						\$

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 728.00
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

EL 701 020 822 US

Respectfully submitted,

Daniel P. Stewart

Daniel P. Stewart
Attorney for Applicants
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MODIFIED PTO/SB/35 (11-00)

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)	Inventors	Paul Hoffman and Doug Mathews
	Title	Shielded Semiconductor Package With Single-Sided Substrate And Method For Making The Same
	Atty Docket Number	M-9954 US

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

May 4, 2001
Date



Daniel P. Stewart
Attorney for Applicants
Reg. No.: 41,332

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

Patent "Request"